

SET TO GROW

**Investor Presentation
October 2025**

SILTRONIC AT A GLANCE

4,400

employees
worldwide

4

world-class
production sites

1.4

billion EUR
sales in 2024

50+

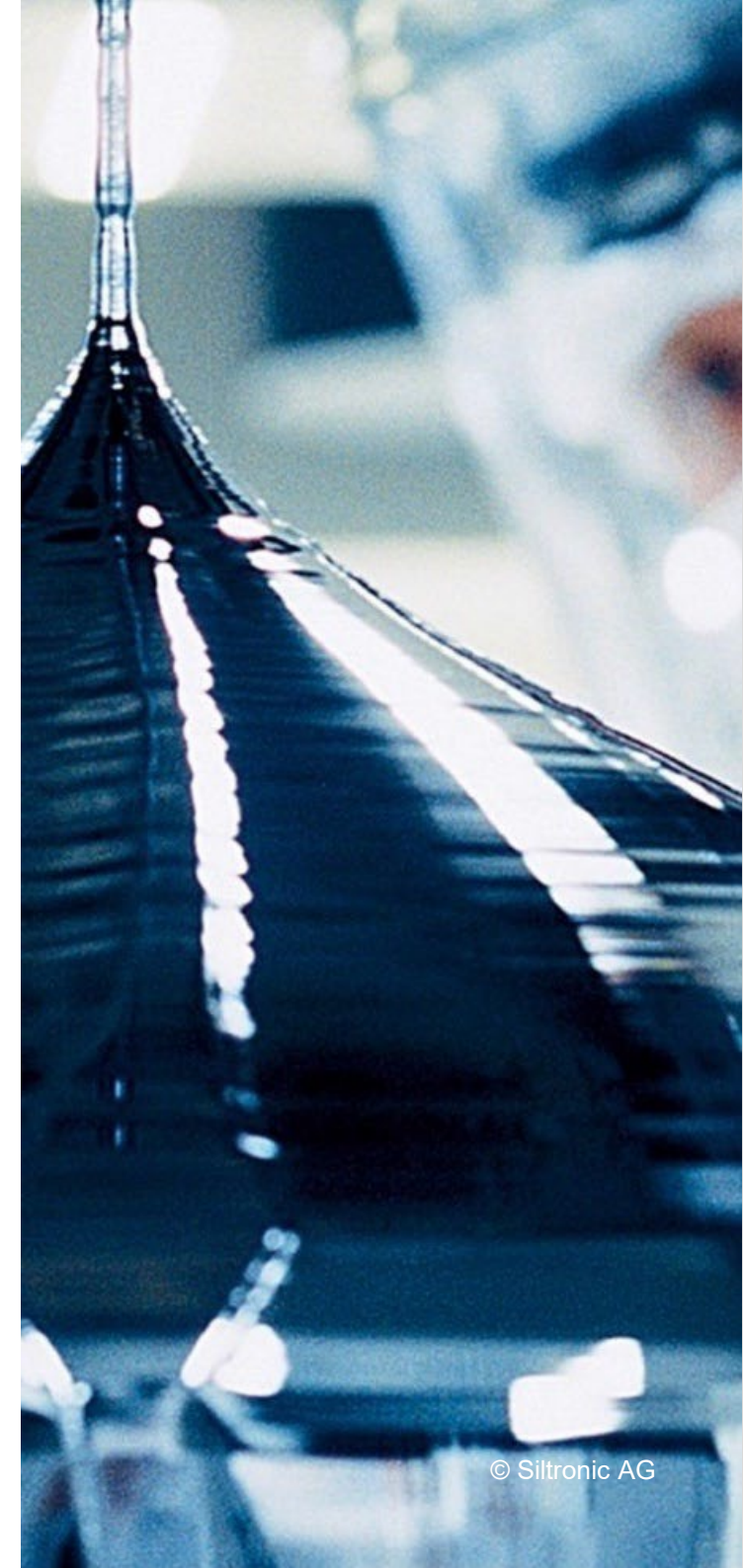
years of history
in silicon technologies

Supplier

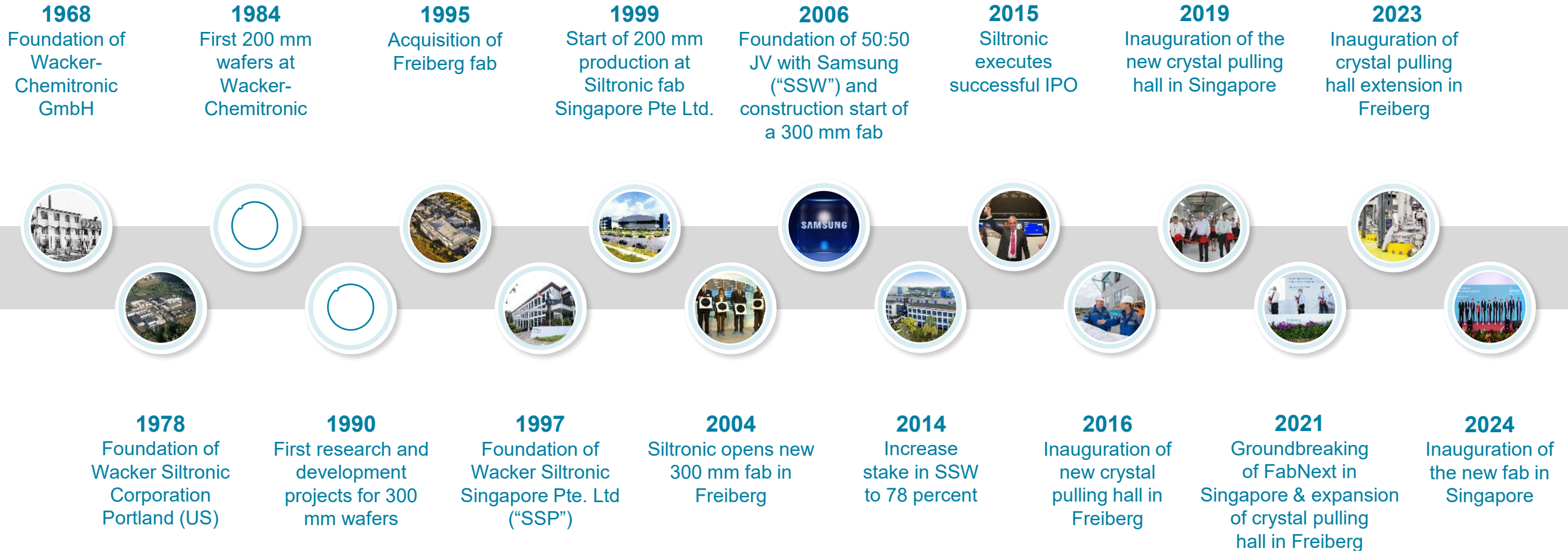
to top
semiconductor producers

26

percent
EBITDA margin in 2024



50+ YEARS OF HISTORY – A STORY OF SUCCESS AND INNOVATION



OUR INTERNATIONAL PRODUCTION NETWORK SERVES CUSTOMERS AROUND THE GLOBE

Singapore



Singapore



SSW*



300
mm

SSP

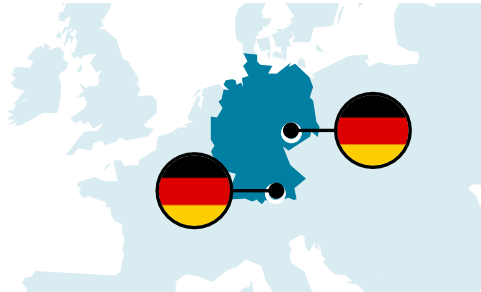
200
mm



300 mm

volume production in
Germany & Singapore

Germany



Germany (Burghausen, Freiberg)



CP

300
mm



R&D

hub in Burghausen

USA



USA (Portland / Oregon)



200
mm

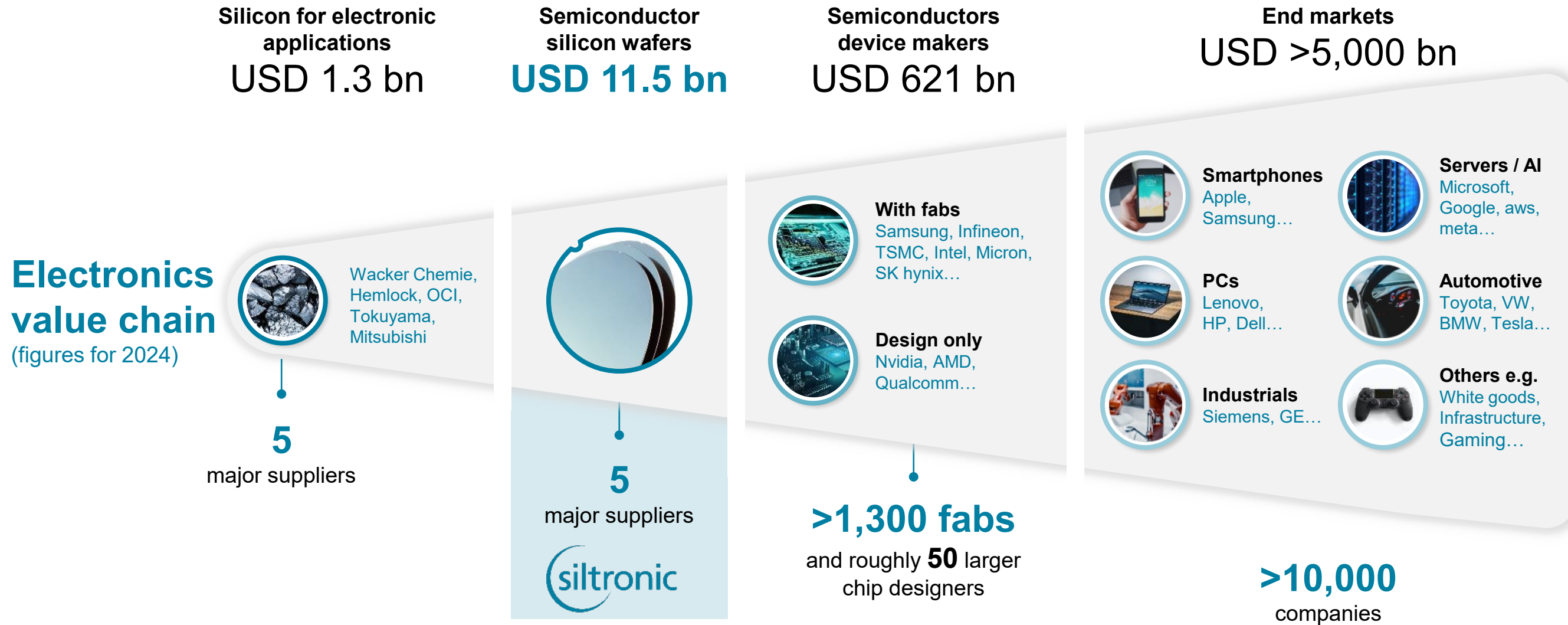


Leading Edge

production

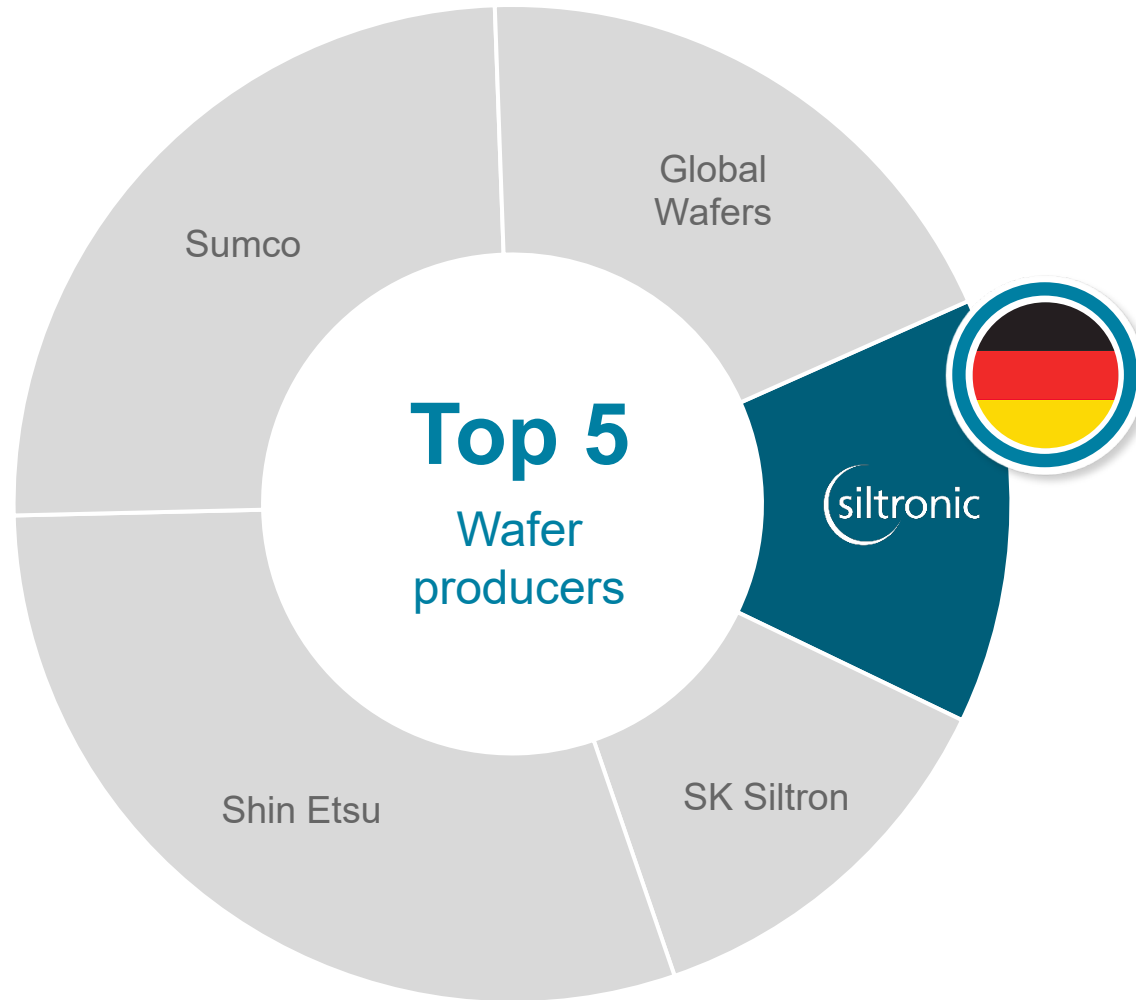
*JV with Samsung Electronics

THE WAFER SUPPLIERS ARE FUELING THE WHOLE ELECTRONICS VALUE CHAIN



Source: TechInsights & other companies, WSTS (Silicon based), SEMI SMG, Siltronic Marketing

SILTRONIC IS WELL POSITIONED AS THE ONLY WESTERN-BASED WAFER MANUFACTURER



Around 80%
of the market is
served by the Top 5

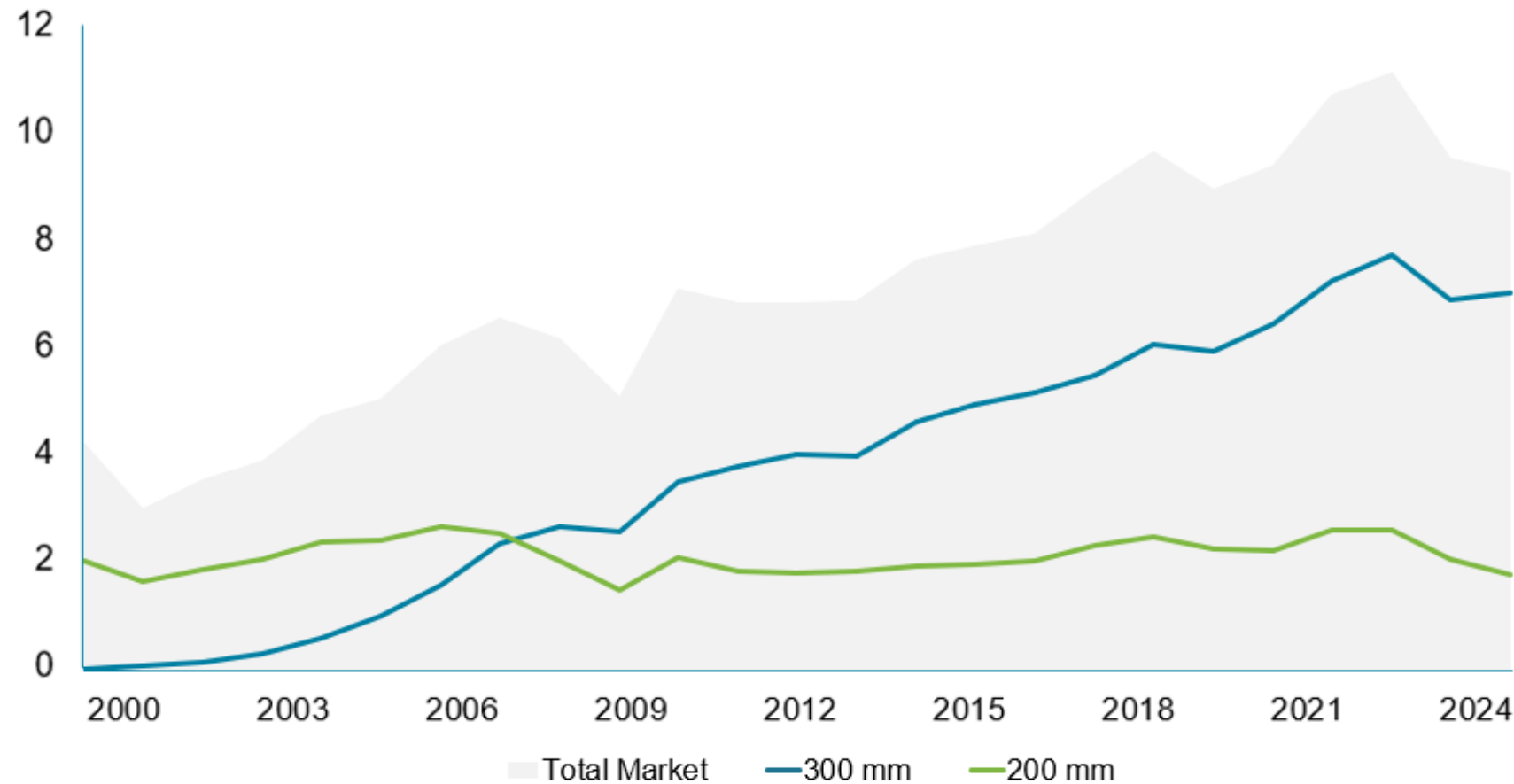


Only western
based wafer
manufacturer

Source: Q1-Q3 2024 Quarterly revenue reports by SEMI reporting companies with Siltronic estimates on silicon wafer revenues

WAFER DEMAND GROWTH EXPECTED TO CONTINUE (CAGR¹ 4-5%), DRIVER 300 mm WAFERS

Wafer Demand per Diameter
in mn 300 mm equivalents



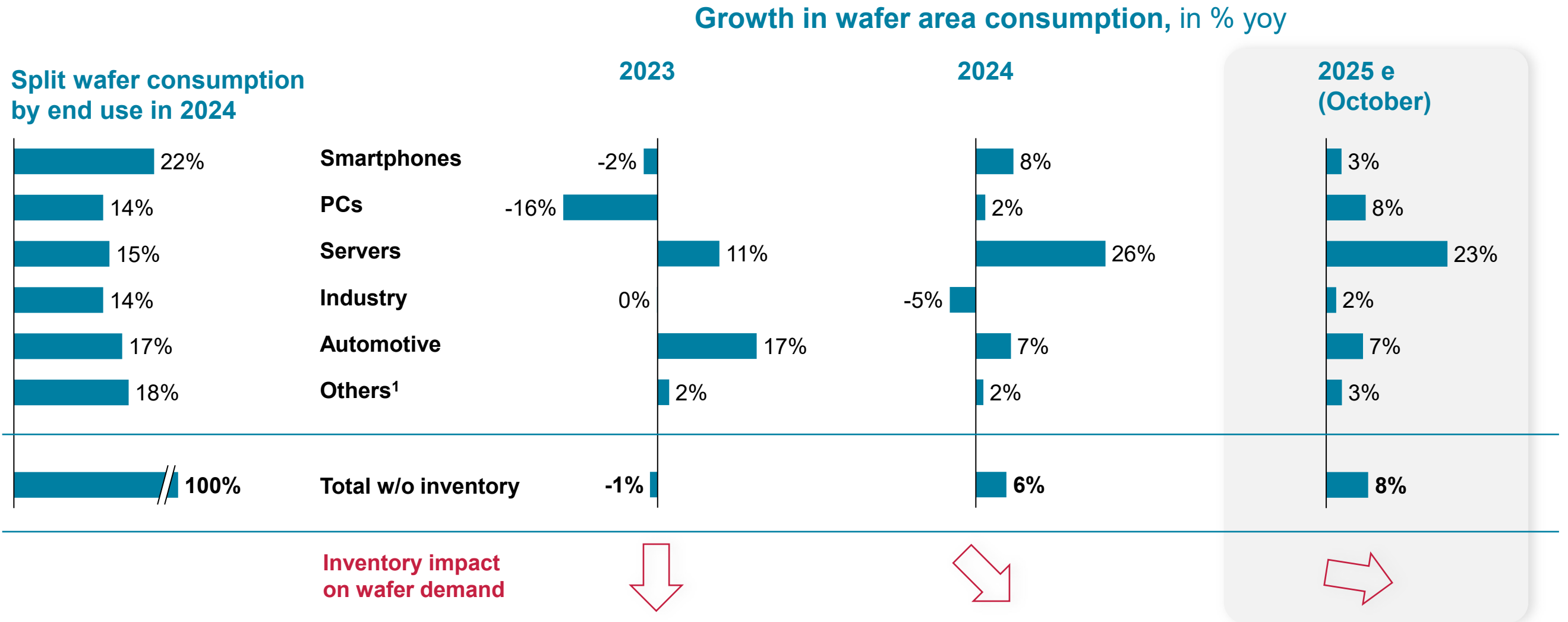
CAGR 6%
for 300 mm



CAGR 1%
for 200 mm

Source: Siltronic estimates; ¹CAGR = Compound Annual Growth Rate

WAFER CONSUMPTION 2025 UP TO 8% ON AI MOMENTUM INVENTORY HEADWINDS PERSIST BUT DECREASING

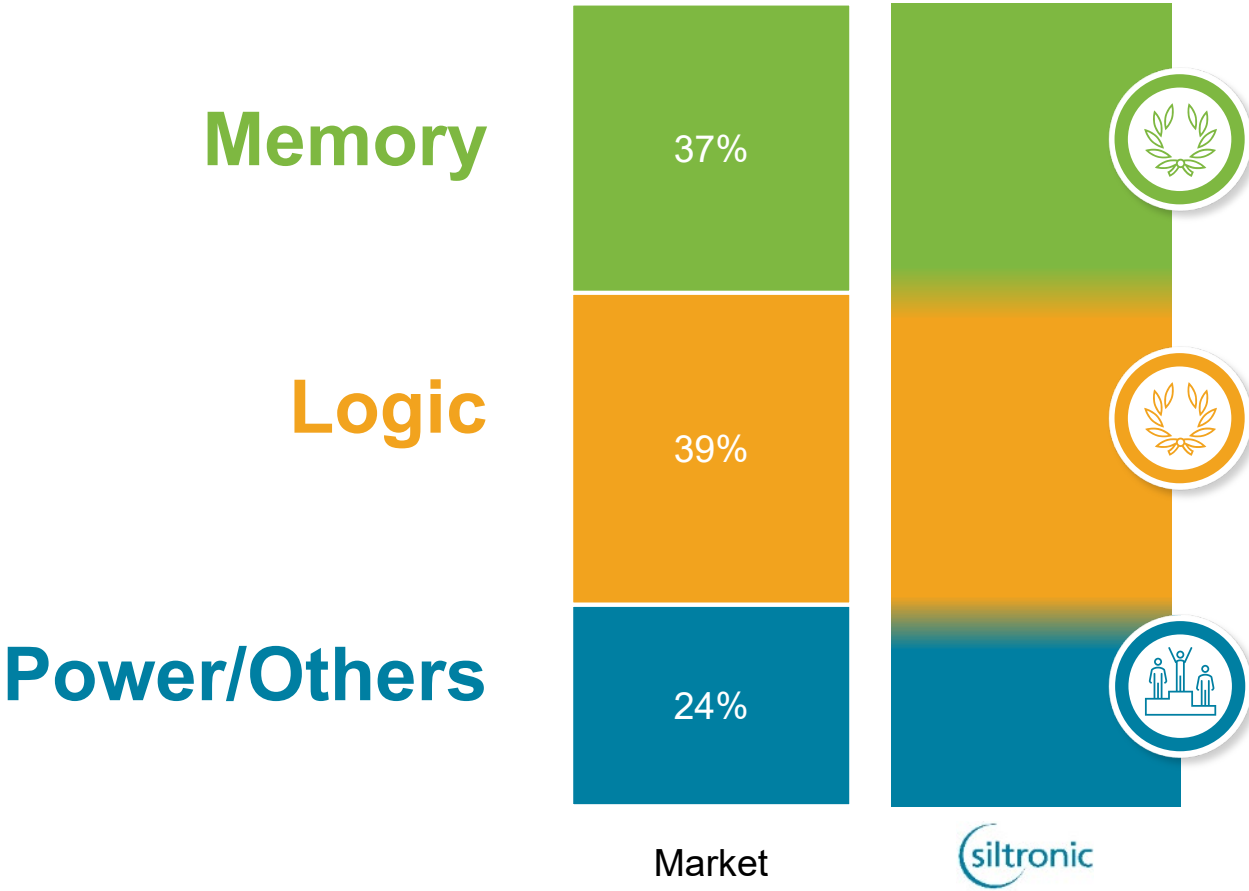


¹Infrastructure Telecommunications, game consoles, consumer electronics such as televisions, white goods such as refrigerators

Source: Siltronic estimates; Chart not to scale

SILTRONIC HAS A WELL-DIVERSIFIED AND RESILIENT PRODUCT MIX IN ALL THREE SEMI-SEGMENTS

Demand by segments in % of total demand in 2024



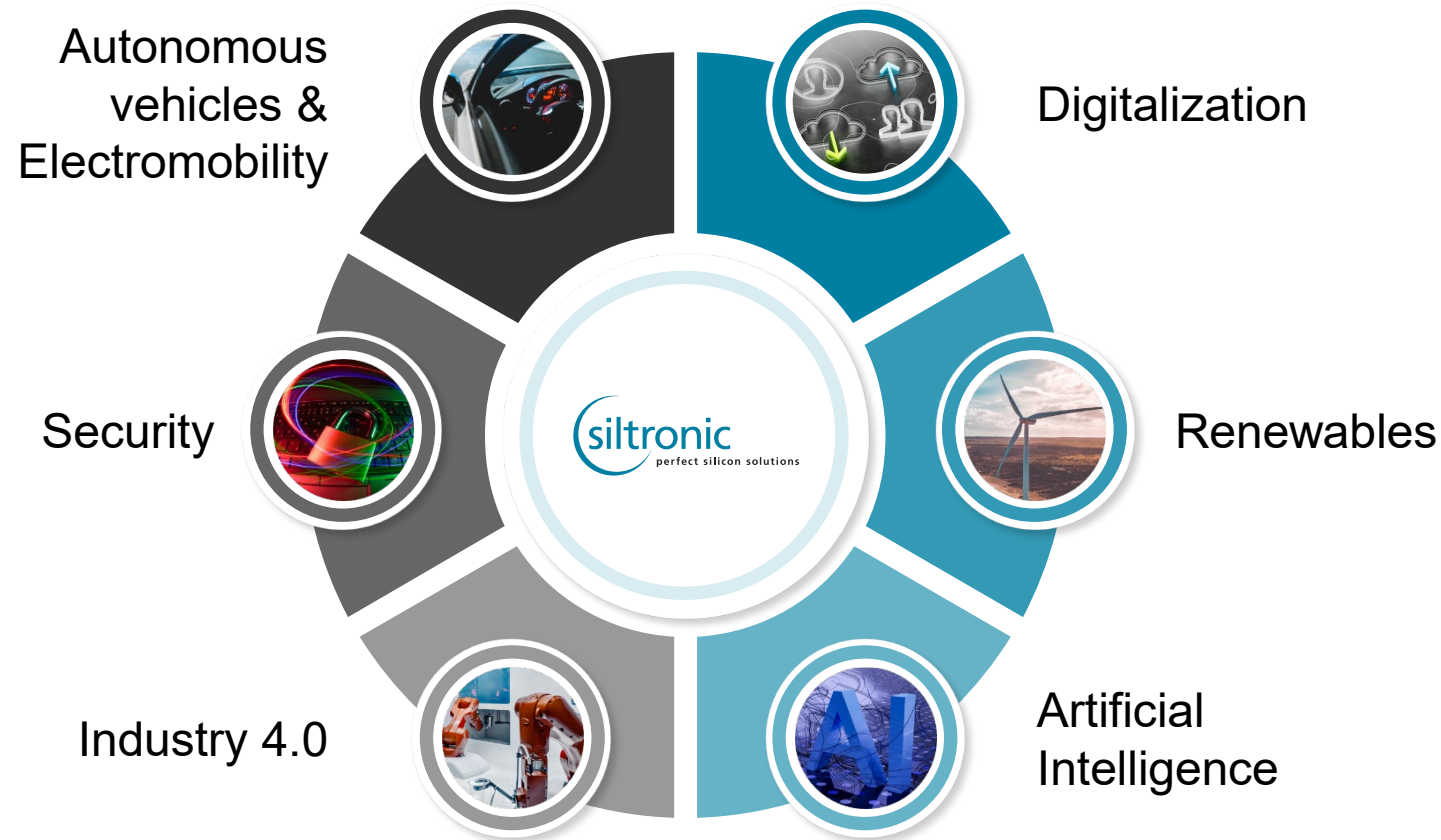
Leading Edge
Supplier



Power
Leading position

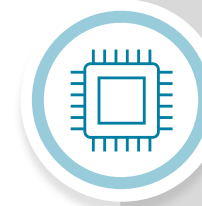
Source: Siltronic Marketing

MEGATRENDS WILL DRIVE WAFER DEMAND



Siltronic

is well positioned to support each megatrend



All segments

will participate and Power with over proportional growth

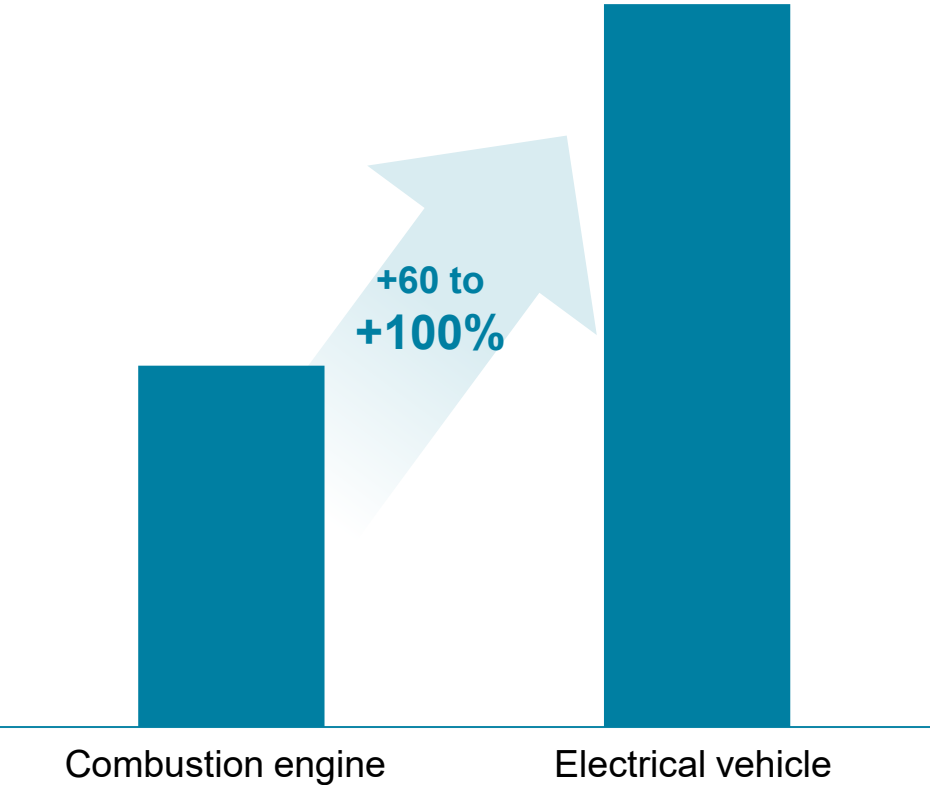


Key benefits

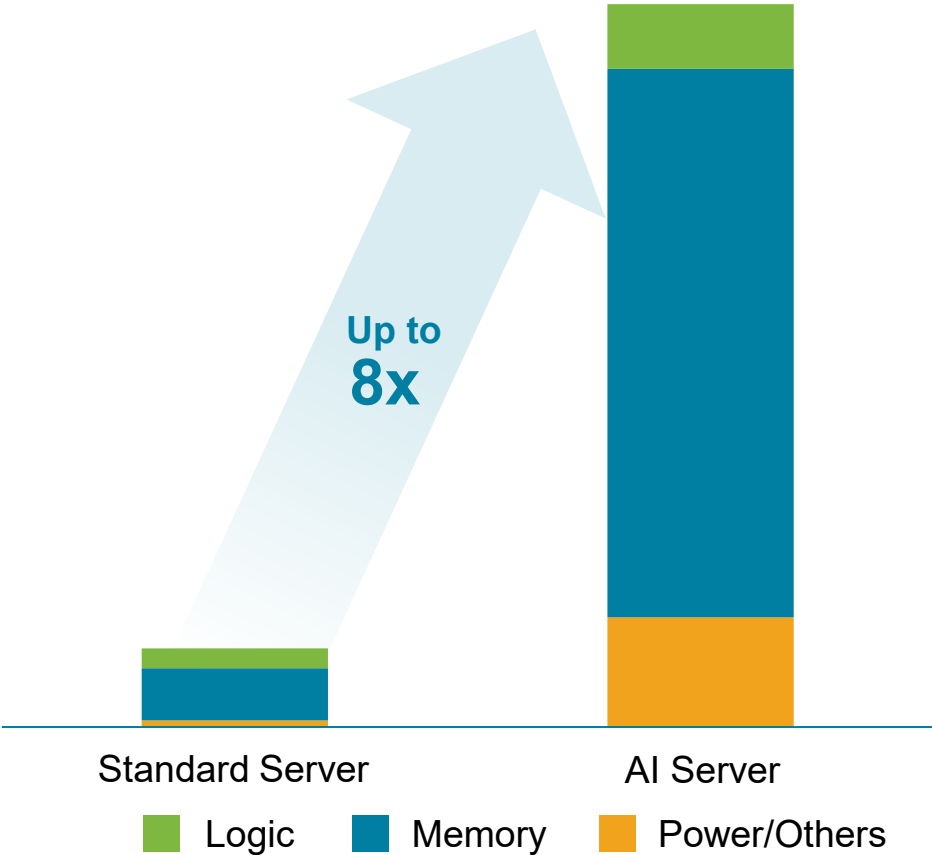
from strategic focus on Leading Edge and Power market

FOR EXAMPLE: ELECTROMOBILITY AND AI ARE PUSHING WAFER DEMAND

Silicon content between combustion engine and electrical vehicle in cm² per car



Silicon content between standard server vs. AI server in cm² per server



Source: BS Sept. 2023 Global I/O Semiconductors; UBS May 2023; Omdia Q4 2022; Siltronic Marketing estimates

FLAGSHIP PROJECT: INAUGURATION OF OUR NEW 300 mm FAB IN SINGAPORE TOOK PLACE IN JUNE

Facts



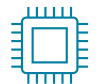
EUR 2 billion capex until 2024, in 2025 clearly reduced



Key prime customer qualifications completed



EBITDA margin above 50%+ mid-term



First time 300 mm epi in Singapore



Up to 80% LTA share with high prepayments



2024 and 2025 with reduced ramp speed

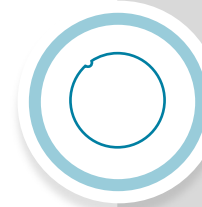
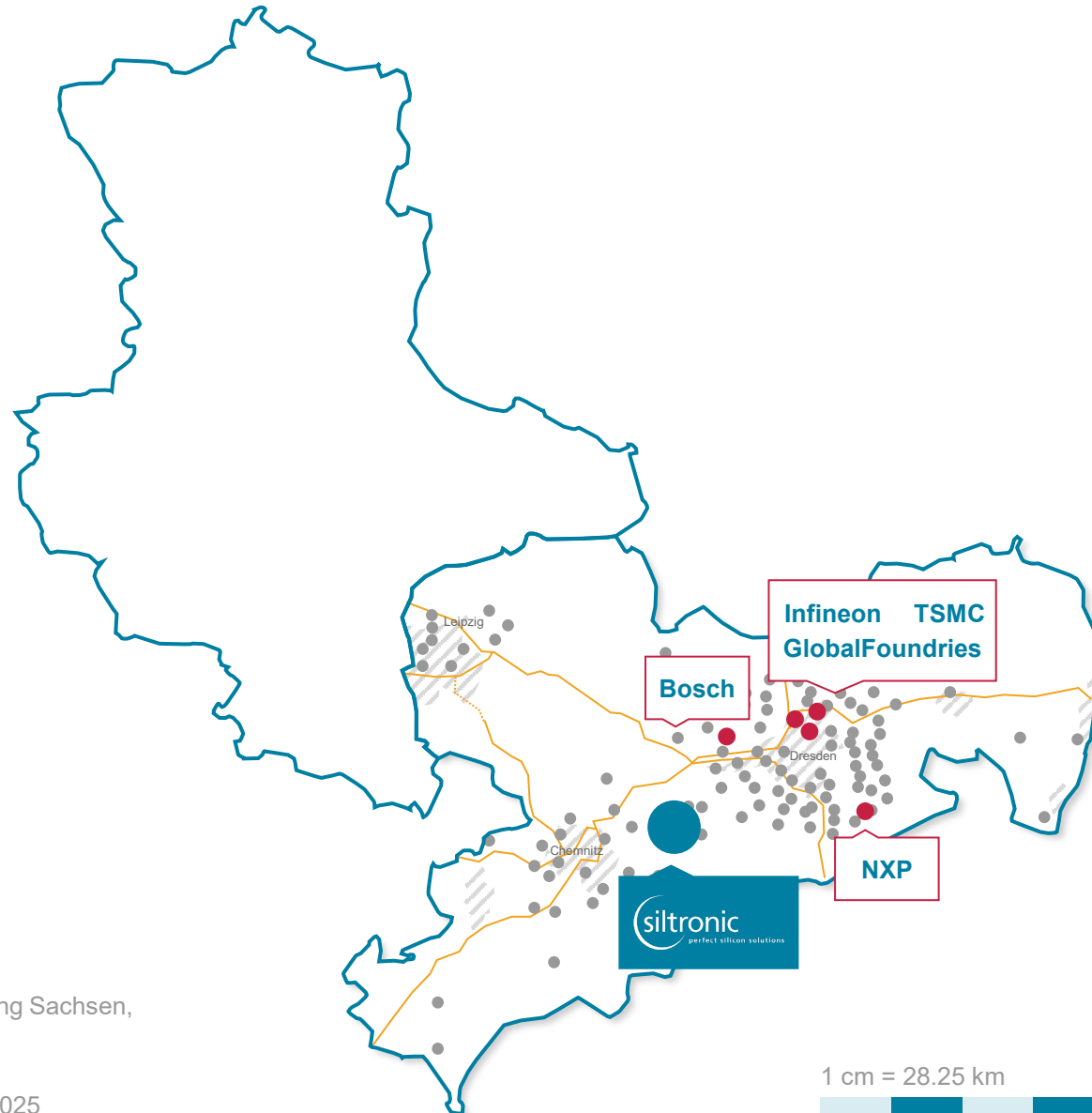


Highly automated and high economies of scale



LTA = Long Term Agreement; epi = epitaxial wafers (mostly used for the logic industry)

IN FREIBERG WE FURTHER IMPROVED PRODUCT MIX FUELED BY INVESTMENTS



**Every
2nd to 3rd**
semiconductor in the
EU is from this region



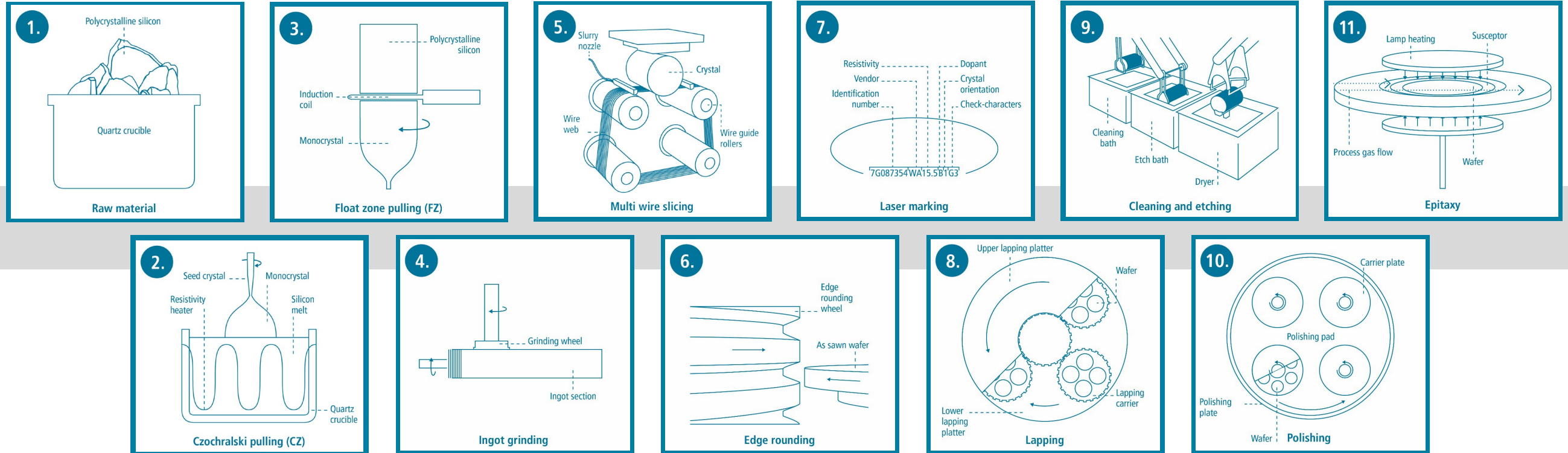
Investments
of more than EUR 1 bn
since 1995 by Siltronic



First-class
geographical position
in light of EU ambitions

Source: Siltronic; Silicon Saxony/Wirtschaftsförderung Sachsen,
*delayed by at least 2 years

WAFER PRODUCTION PROCESS



STRONG FOCUS ON GROWTH DRIVERS R&D AND INNOVATION

R&D

hub in Burghausen

450

R&D employees

1,900

patents

4-5%

of sales planned
as R&D spendings



Partnering with leading innovation platforms



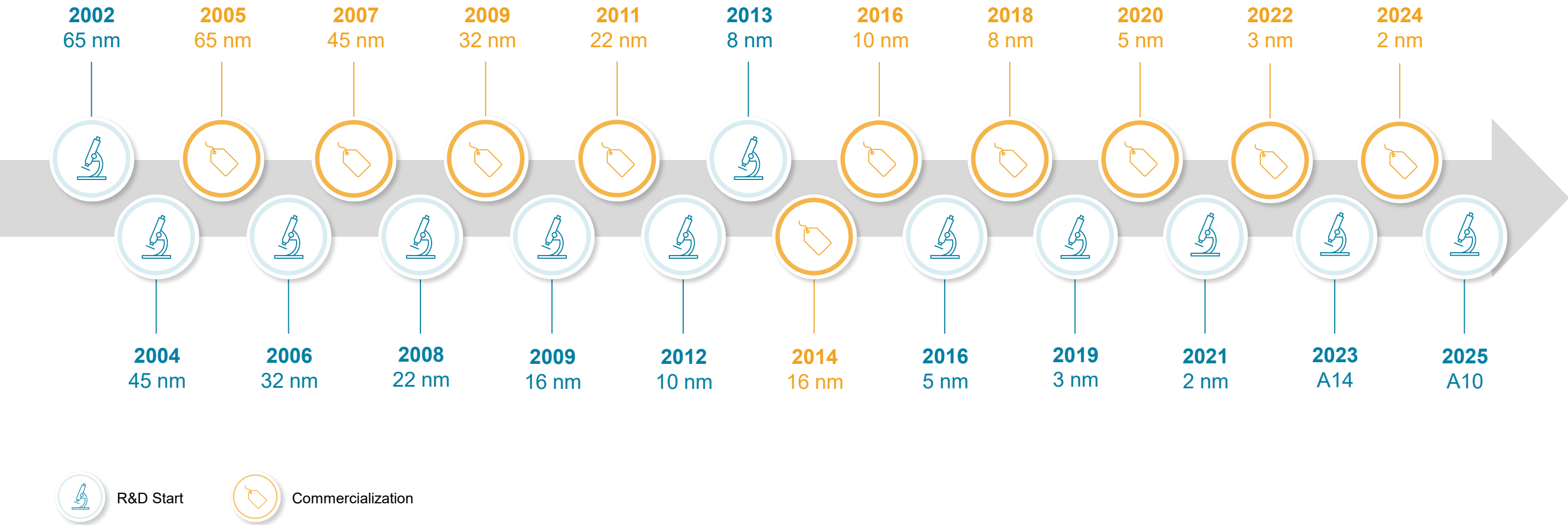
Leibniz Institute
for high
performance
microelectronics



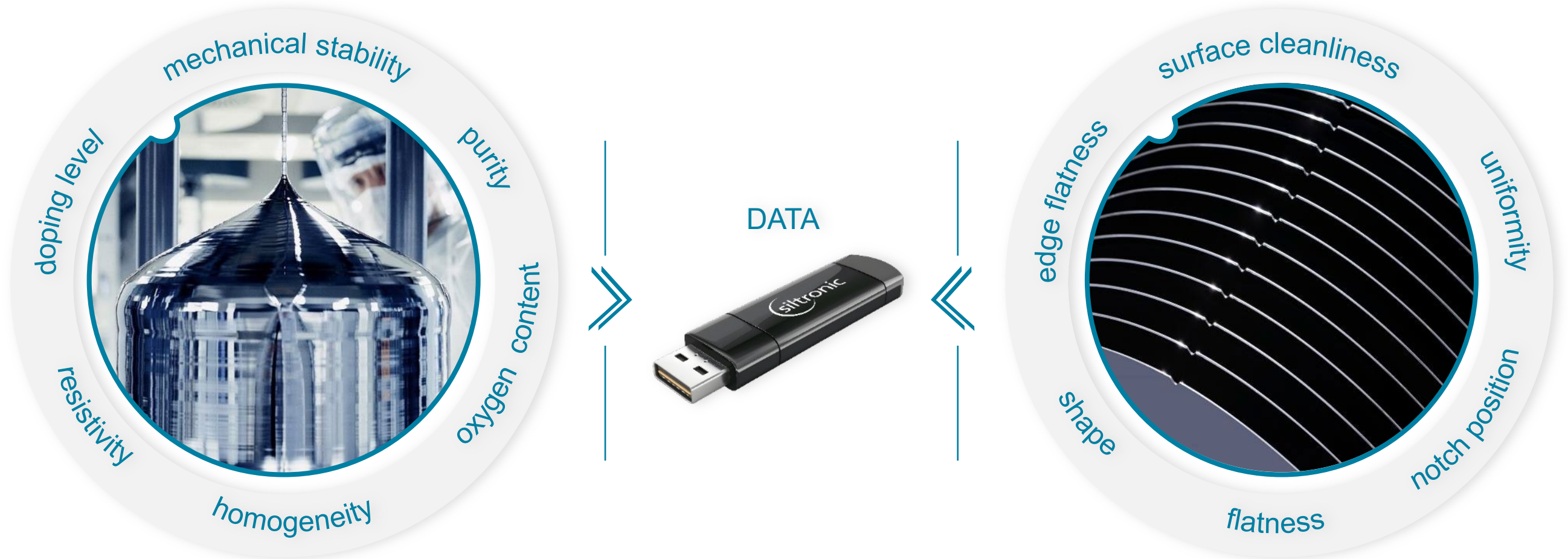
R&D Innovation Strategy

- Stay one generation ahead as a **Technology Leader**
- Focus on **Leading Edge** and **Power**
- Find new business opportunities and **expand** our product **portfolio**

SILTRONIC HAS A PROVEN TRACK RECORD AS A TECHNOLOGY LEADER



A NUMBER OF KEY INGOT AND WAFER PROPERTIES DEFINE THE WAFER SPECIFICATION AND ITS FURTHER USE BY THE CUSTOMER



PURITY AND FLATNESS REQUIREMENTS FOR WAFERS ARE EXTREME, AS SCALING THEM INTO THE MACRO WORLD SHOWS

Particles

Particle size specified in the nm range. Requirements are equivalent to a maximum of 10 grains of sand distributed over the city of Munich.



nm = nanometer

Flatness

20 nm on a wafer are equivalent to the height of a leaf on the surface of Lake Chiemsee – or a single bacteria on a tennis court.

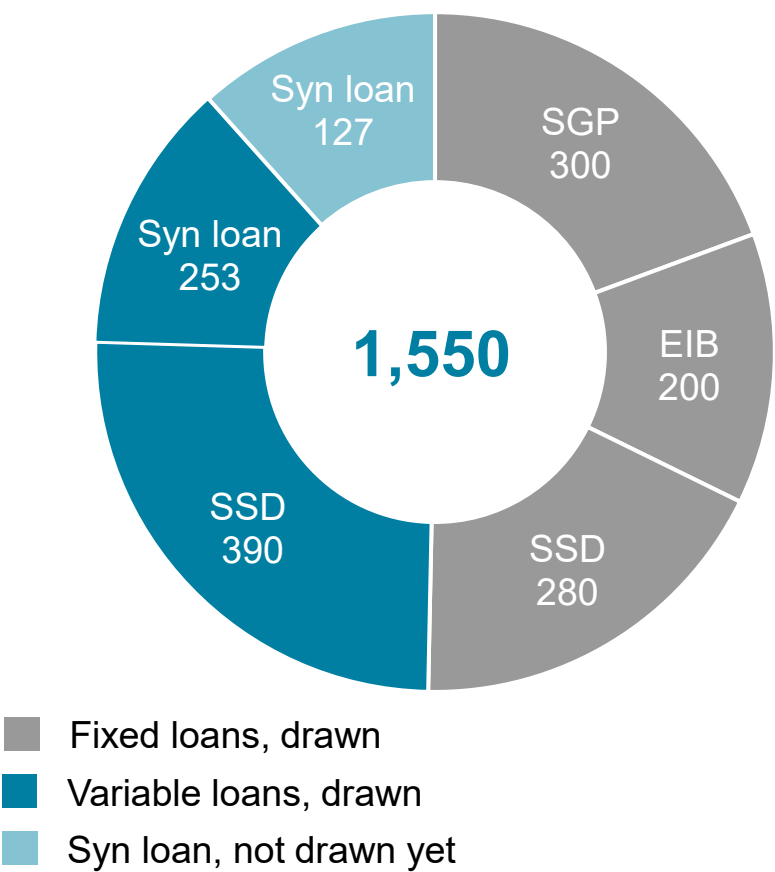


OUTLOOK AND FINANCIAL STRENGTH

Increased risks due to indirect tariff and FX risks

DEBT STRUCTURE UNCHANGED VS. PREVIOUS QUARTER

Debt financing instruments in EUR million



Figures rounded

SSD=Schuldscheindarlehen (Promissory Note Loan)

Maturity profile of debt financing in EUR million

2025	2026	2027	Σ 2028 – 2032
65	105	250	1.130

Liquidity in EUR million

September 30, 2025	Syn loan (not drawn)
509	127



Prepayments

of EUR 50 mn expected to be refunded in the next 12 months

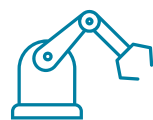


Interest

expenses in the ballpark of EUR 50 mn expected in 2025

FOCUSING ON WHAT WE CAN CONTROL: CAPEX, COSTS AND CASH

Strict capex discipline



Deferred capacity spend, restrictive project approvals

Cost program



Full-scope cost management, tackling all cost drivers

Other cash measures



From SD closure to comprehensive working capital management to dividend cuts

Major cost items 2025



Labor



Depreciation



Supplies



Polysilicon



Energy

CAPEX DISCIPLINE: AGAIN SIGNIFICANT REDUCTION IN 2025

Capex, in EUR million

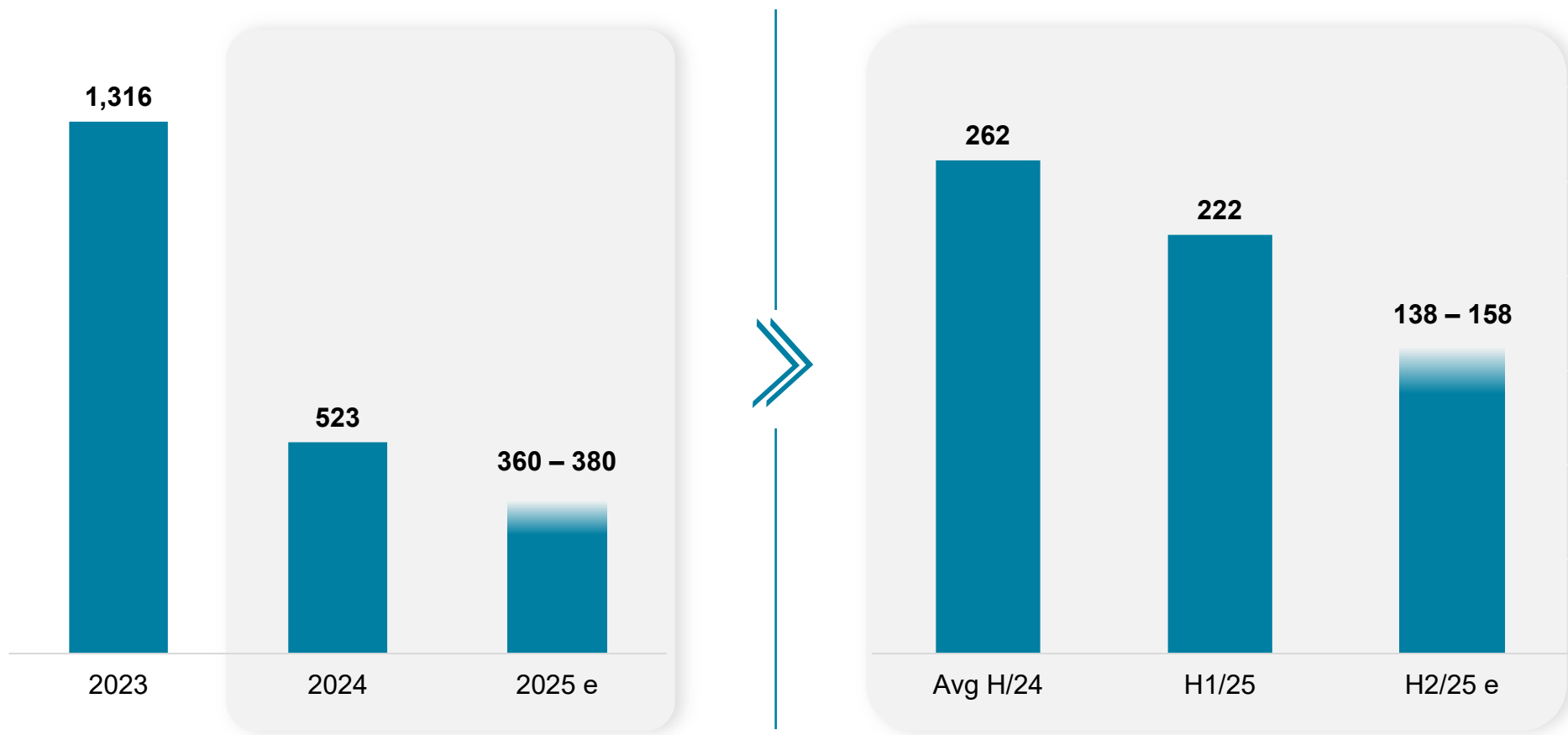


Chart not to scale. Avg H/24 is average of H1 and H2 2024.



Capex 2025

Ongoing focus on new Fab in SGP



Further reduction

in H2 underlines Capex discipline



Investments

are adapted to market environment

COMPREHENSIVE INITIATIVES TACKLE ALL COST DRIVERS



Cost program in place

- Continuation of our track record in successful **cost reductions**
- Global, **integrated cross-functional approach**
- Targeting **all cost categories**
- Initiatives outlined through year-end 2026 with increasingly **positive contribution to results**



Temporary headwind from ramp cost of new 300 mm Fab

- **Additional fixed costs** from the new fab, which are not yet sufficiently absorbed during the ramp phase
- Capitalized before August 2025 and since **then impacting P&L and margins**
- **Mid-term margin burden** is expected; however, decreasing as volume grows



Headcount

Significant reduction by 10% despite ramp of new fab¹



Electricity

efficiency program in place with a reduction of 5%¹



Targeting

all cost categories

¹Figures in examples are as of Sep 30, 2025 vs. end of 2022

SILTRONIC'S TECHNOLOGICAL LEADERSHIP AND EXCELLENCE RECOGNIZED WITH MULTIPLE AWARDS IN THE LAST 12 MONTHS



**Best Carbon
Reduction
Partner Award**

TSMC, December 2024



**EPIC Supplier
Award**

Intel, April 2025



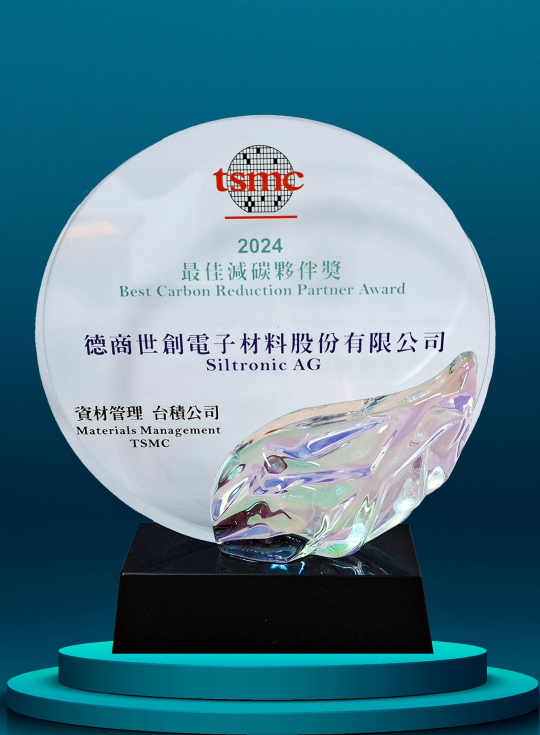
**BEST in Value
Award**

Samsung, September 2025



**Best Supplier
Award**

SSMC, September 2025



GUIDANCE CONFIRMED AND SPECIFIED

Sales

Mid-single digit below 2024
EUR/USD 1.17 for H2 2025
(Previous: EUR/USD 1.15)

EBITDA Margin

Between 22% and 24%
(Previous: 21% and 25%)

Depreciation

Between EUR 340 and 360 mn
(Previous: EUR 340 to 400 mn)

EBIT

Significant decline

Capex

Between EUR 360 and 380 mn
(Previous: EUR 350 and 400 mn)

Net cash flow

Significantly improved compared to
previous year but still notably negative

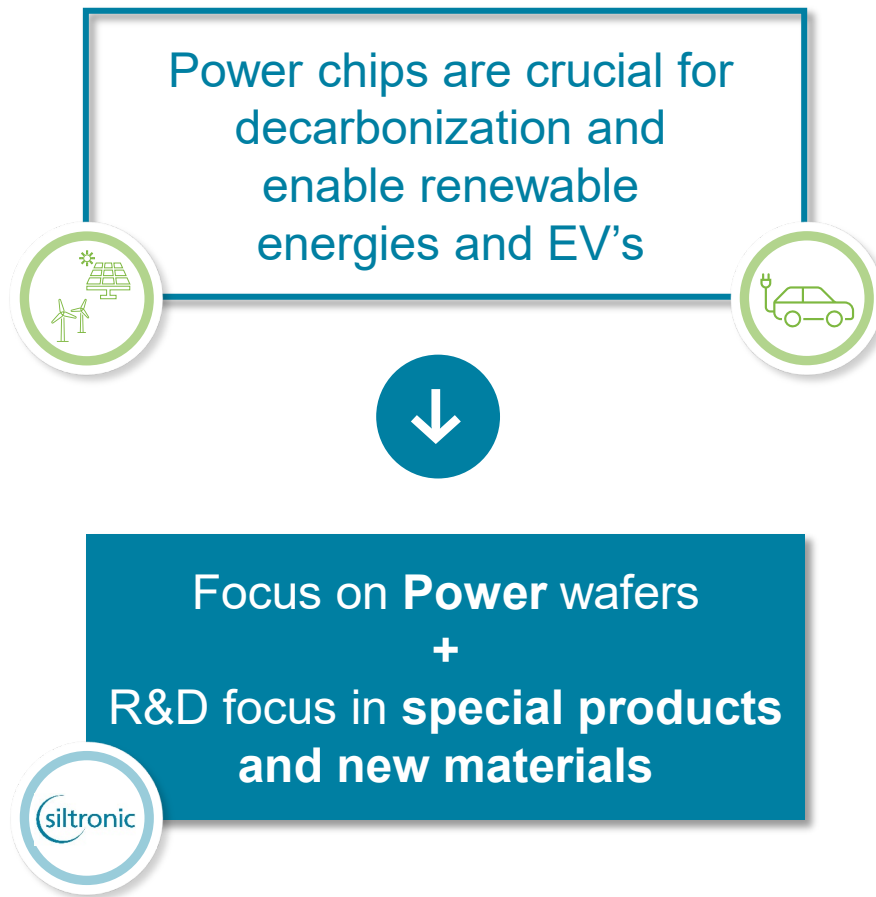


ESG @ SILTRONIC

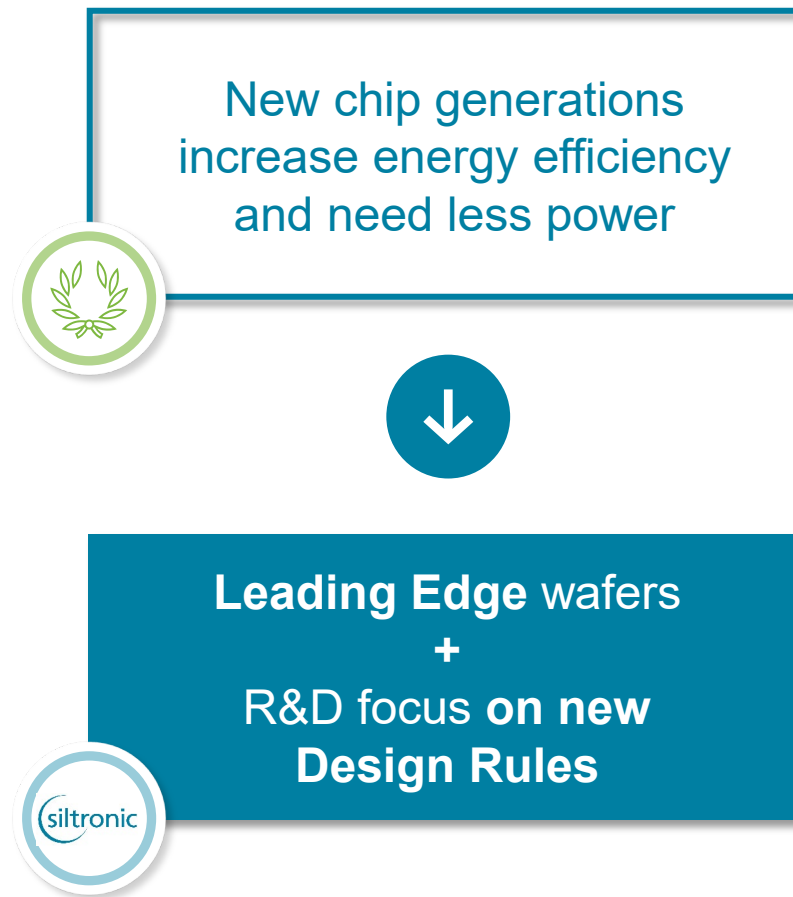
Clear commitment to an emission-free future

SILTRONIC IS ENABLING TECHNOLOGIES FOR A SUSTAINABLE FUTURE

Power focus



Leading edge focus



Strategy

on leading edge and power wafers supports sustainability strategy



Investments

needed to keep our equipment state of the art for leading edge wafers



R&D focus

is crucial for sustainability strategy

AMBITIOUS TARGETS AND GLOBAL COMMITMENTS KEEP US GOING



Climate – Scope 1+2 CO₂ emissions

2030: -42%¹

2045: Net zero²

Status 2024: -27%



Energy – renewable

2030: 60% share

2045: 100% share

Status 2024: 19% share³



Siltronic supports the
10 principles of the UN Global Compact.

We contribute to the sustainable
development goals of the UN.

As a supplier to the electronics industry, Siltronic is a
“Regular” member of the Responsible Business
Alliance (RBA).

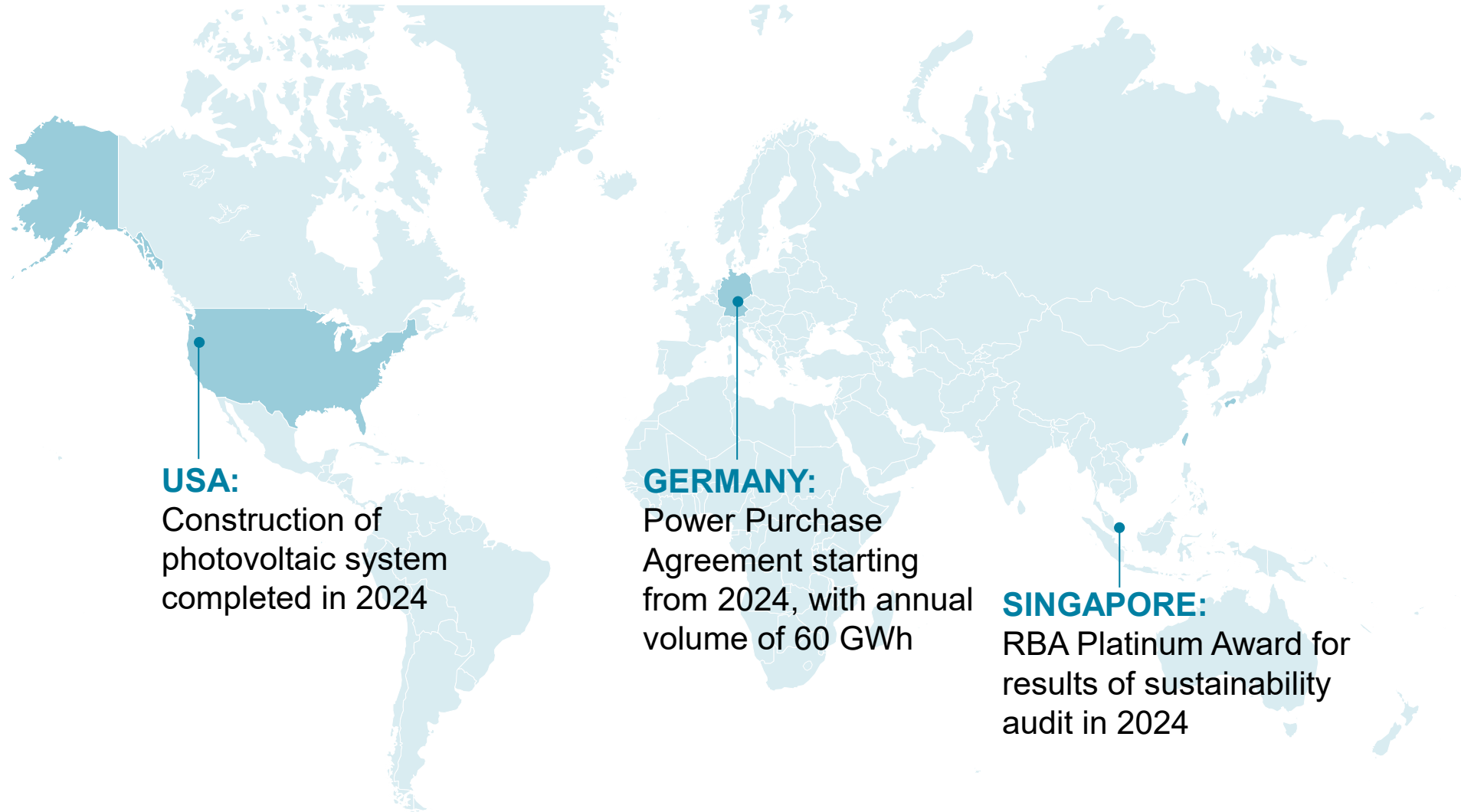
Siltronic participates in CDP Climate change and
Water security evaluations.

With our membership at RE100, we are dedicated to
make our contribution to global decarbonization.

(1) absolute reduction, base year 2021, (2) Net zero: GHG emissions released into the atmosphere equal the amount removed

(3) based on RE100 criteria

SUSTAINABILITY HIGHLIGHTS



USA:

Construction of photovoltaic system completed in 2024

GERMANY:

Power Purchase Agreement starting from 2024, with annual volume of 60 GWh

SINGAPORE:

RBA Platinum Award for results of sustainability audit in 2024



THE SILTRONIC EXECUTIVE BOARD



Dr. Michael Heckmeier
CEO

- CEO since May 2023
- 25 years at Merck
- Studied physics and mathematics, PHD in physics
- MBA, general management



Claudia Schmitt
CFO

- CFO since July 2023
- 16 years at Siltronic
- 11 years at Wacker Chemie AG
- Studied business administration



Klaus Buchwald
COO

- COO since June 2024
- 21 years at Infineon
- 4 years at Rohde & Schwarz
- Studied mechanical and industrial engineering

EXECUTIVE SUMMARY

KEY TAKEAWAYS – CLEAR COMMITMENT TO PROFITABLE GROWTH AS A TECHNOLOGY LEADER

Proven success in a cyclical industry



Megatrends **AI, Digitalization, and Electromobility** will drive wafer demand to new levels



New fab will improve our position and drive growth



Clear commitment to **R&D, Sustainability and Innovation** to stay ahead of the curve



Financial Calendar and Events

Nov 12, 2025	Nov 13, 2025	Nov 18, 2025	Dec 1, 2025	Jan 19, 2026	Feb 3, 2026	Mar 12, 2026
MKK, Munich	MS TMT Conference, Barcelona	BNP Paribas Exane Investor Fieldtrip, Munich	Berenberg European Conference 2025, London	Kepler, German Corporate Conference, Frankfurt	Preliminary FY25 Results	FY25 Results

Investor Relations Contact



Stephanie Malgara
investor.relations@siltronic.com
Tel. +49 89 8564-3133

The information contained in this presentation is for background purposes only and is subject to amendment, revision and updating. Certain statements contained in this presentation may be statements of future expectations, future financial performance and other forward-looking statements that are based on management's current views and assumptions and involve known and unknown risks and uncertainties. In addition to statements which are forward-looking by reason of context, including without limitation, statements referring to risk limitations, operational profitability, financial strength, performance targets, profitable growth opportunities and risk adequate pricing, words such as "may", "will", "should", "expects", "plans", "intends", "anticipates", "believes", "estimates", "predicts", "continue", "projects" or "seeks", "potential", "future", or "further" and similar expressions may identify forward-looking statements. By their nature, forward-looking statements involve a number of risks, uncertainties and assumptions which could cause actual results or events to differ materially from those expressed or implied by the forward-looking statements. These include, among other factors, changing business or other market conditions, currency and interest fluctuations, introduction of competitive products, poor acceptance of new products and services, change of the corporate strategy and the prospects for growth anticipated by the management. These and other factors could adversely affect the outcome and financial effects of the plans and events described herein. Statements contained in this presentation regarding past trends or activities should not be taken as a representation that such trends or activities will continue in the future. Siltronic AG does not undertake and does not intend to undertake any obligation to update or revise any statements contained in this presentation, whether as a result of new information, future events or otherwise. In particular, you should not place any reliance on forward-looking statements which speak only as of the date of this presentation.